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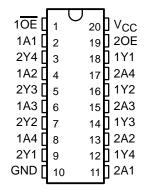
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs

description

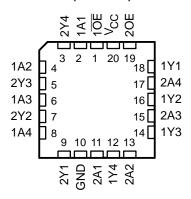
These octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. Taken together with the 'F240 and 'F244, these devices provide the choice of selected combinations of inverting and noninverting outputs, symmetrical \overline{OE} (active-low output-enable) inputs, and complementary OE and \overline{OE} inputs.

The SN54F241 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74F241 is characterized for operation from 0°C to 70°C.

SN54F241 . . . J PACKAGE SN74F241 . . . DW OR N PACKAGE (TOP VIEW)



SN54F241 . . . FK PACKAGE (TOP VIEW)

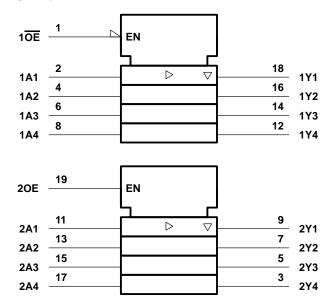


FUNCTION TABLES

INPU	JTS	OUTPUT
10E	1A	1Y
Н	Χ	Z
L	Н	Н
L	L	L

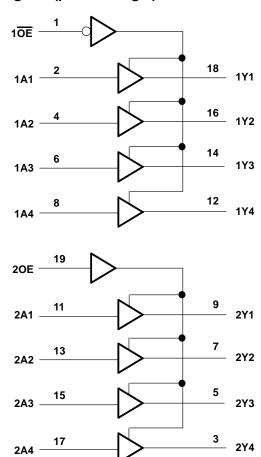
INP	JTS	OUTPUT
20E	2A	2Y
Н	Н	Н
Н	L	L
L	X	z

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}		0.5 V to 7 V
Input voltage range, V _I (see Note 1)		1.2 V to 7 V
Input current range		-30 mA to 5 mA
	the disabled or power-off state	
Voltage range applied to any output in t	the high state	0.5 V to V _{CC}
Current into any output in the low state:	: SN54F241	96 mA
•	SN74F241	128 mA
Operating free-air temperature range:	SN54F241	-55°C to 125°C
	SN74F241	0°C to 70°C
Storage temperature range		-65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.



recommended operating conditions

		SN54F241		SN74F241			UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.8			0.8	V
ΙΙΚ	Input clamp current			-18			-18	mA
IOH	High-level output current			- 12			- 15	mA
lOL	Low-level output current			48			64	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST COMPITIONS		S	N54F24		S	UNIT		
	METER TEST CONDITIONS	1 CONDITIONS	MIN	TYP†	MAX	MIN	TYP	MAX	UNII
VIK	$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V
		IOH = -3 mA	2.4	3.3		2.4	3.3		
Vou	V _{CC} = 4.5 V	$I_{OH} = -12 \text{ mA}$	2	3.2					V
VOH		$I_{OH} = -15 \text{ mA}$				2	3.1		V
	$V_{CC} = 4.75 \text{ V},$	IOH = -3 mA				2.7			
V	V45V	$I_{OL} = 48 \text{ mA}$		0.38	0.55				V
VOL	$V_{CC} = 4.5 \text{ V}$	$I_{OL} = 64 \text{ mA}$					0.42	0.55]
lozh	$V_{CC} = 5.5 \text{ V},$	V _O = 2.7 V			50			50	μΑ
lozL	V _{CC} = 5.5 V,	V _O = 0.5 V			-50			-50	μΑ
Ц	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
Iн	V _{CC} = 5.5 V,	V _I = 2.7 V			20		-	20	μΑ
OE or OE	V22	5.5.1/			– 1			– 1	A
IIL Any A	$V_{CC} = 5.5 \text{ V},$	$V_{CC} = 5.5 \text{ V},$ $V_{I} = \text{CF.b}' \text{ V}$			- 1.6			- 1.6	mA
los [‡]	V _{CC} = 5.5 V,	VO = 0	-100		-225	-100		-225	mA
		Outputs high		40	60		40	60	
Icc	1 00	Outputs low		60	90		60	90	mA
		Outputs disabled		60	90		60	90	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

SN54F241, SN74F241 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	ТО (ОИТРИТ)	C _I R _I	CC = 5 V _ = 50 p _ = 500 s A = 25°C	F, Ω,	C _L R _L	= 50 pF = 500 Ω			UNIT
			′F241			F241	SN74F241			
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	Any A	Any A Y	1.7	3.6	5.2	1.2	6.5	1.7	6.2	
^t PHL			1.7	3.6	5.2	1.2	7	1.7	6.5	ns
^t PZH	OE or OE	0 5 05	1.2	3.9	5.7	1.2	7	1.2	6.7	20
^t PZL		Y	1.2	5	7	1.2	8.5	1.2	8	ns
^t PHZ	OE or OE	r OE Y	1.2	4.1	6	1.2	7	1.2	7	20
t _{PLZ}	OL UI OE	ſ	1.2	4.1	6	1.2	7.5	1.2	7	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 2: Load circuits and waveforms are shown in Section 1.



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